

500V N-Channel MOSFET

Description

This latest technology has been especially designed to minimize on-state resistance, have a high rugged avalanche characteristics. These devices are well suited for high efficiency switch mode power supplies.

Features

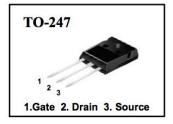
- RDS(on) (Typical 0.26Ω)@VGS=10V
- Gate Charge (Typical 90nC)
- · Improved dv/dt Capability, High Ruggedness
- 100% EAS Test
- · Extended Safe Operating Area
- · RoHS compliant package

Application

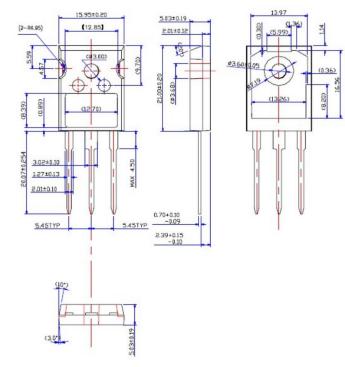
- · High current, High speed switching
- · PFC (Power Factor Correction)
- SMPS (Switched Mode Power Supplies)

Packing & Order Information

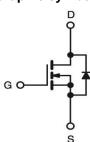
50/Tube; 1,000/Box



RoHS COMPLIANT



Graphic symbol



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)					
Symbol	Parameter	Value	Unit		
V_{DS}	Drain-Source Voltage	500	V		
V_{GS}	Gate-Source Voltage	±30	V		
I _D	Drain Current -Continuous (TC=25°C)	20	А		
	Drain Current -Continuous (TC=100°C)	13	A		
I_{DM}	Drain Current Pulsed	80	A		
E _{AS}	Single Pulsed Avalanche Energy	1400	mJ		
E _{AR}	Repetitive Avalanche Energy	21	mJ		



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Absolute Maximum Ratings (Tc=25°C unless otherwise noted)					
Symbol	Parameter	Value	Unit		
P_D	Power Dissipation (TC = 25 °C)	215	W		
	- Derate above 25°C	2.1	W/°C		
T_{J} , T_{STG}	Operating and Storage Temperature Range	-55 to +175	°C		

Note:

- 1. Pulse width limited by maximum junction temperature
- 2. Duty cycle ≤ 1%

Thermal Resistance Characteristics					
Symbol	Parameter	Max.	Units		
Rthjc	Typical thermal registeres	0.64	°C/W		
$R_{\theta JA}$	Typical thermal resistance	40			

Static Characteristics					
Symbol	Test Conditions		Тур.	Max.	Units
V_{GS}	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	3.0		5.0	V
*R _{DS(ON)}	$V_{GS} = 10 \text{ V}$, $I_D = 10 \text{ A}$		0.21	0.26	Ω
BV _{DSS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu A$	500			V
$\Delta BV_{DSS}/\Delta T_{J}$	$I_D = 250\mu A$, Referenced to 25°C		0.5		V/°C
I _{DSS}	$V_{DS} = 500 \text{ V}$, $V_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}$, $V_{GS} = 0 \text{ V}$, $Tj = 125 ^{\circ}\text{C}$			1 10	uA
I _{GSS}	V _{GS} = ±30			±100	nA

Dynamic Characteristics					
Symbol	Test Conditions	Min	Тур.	Max.	Units
$t_{d(on)}$	$V_{DS} = 250 \text{ V}, I_{D} = 20 \text{ A},$ $R_{G} = 25 \Omega$		60	138	ns
t _r			210	462	ns
t _{d(off)}			170	357	ns
tf			130	286	ns
Qg			90	117	nC
Q_{gs}	$V_{DS} = 400 \text{ V}, I_D = 20 \text{ A},$ $V_{GS} = 10 \text{ V}$		20	26	nC
Q_{gd}			43	56	nC
C _{ISS}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $F = 1.0 \text{MHz}$		3350	4355	pF
C _{OSS}			490	637	pF
C _{RSS}			50	65	pF



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Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units
Is					20	A
I _{SM}					80	
V _{SD}	$I_S = I_F$, $V_{GS} = 0$ V				1.4	V
t _{rr}	1 1 1:5/1/ 4004/			370		ns
Q _{rr}	$I_S = I_F$, diF/dt = 100A/ μ s			3.8		uC

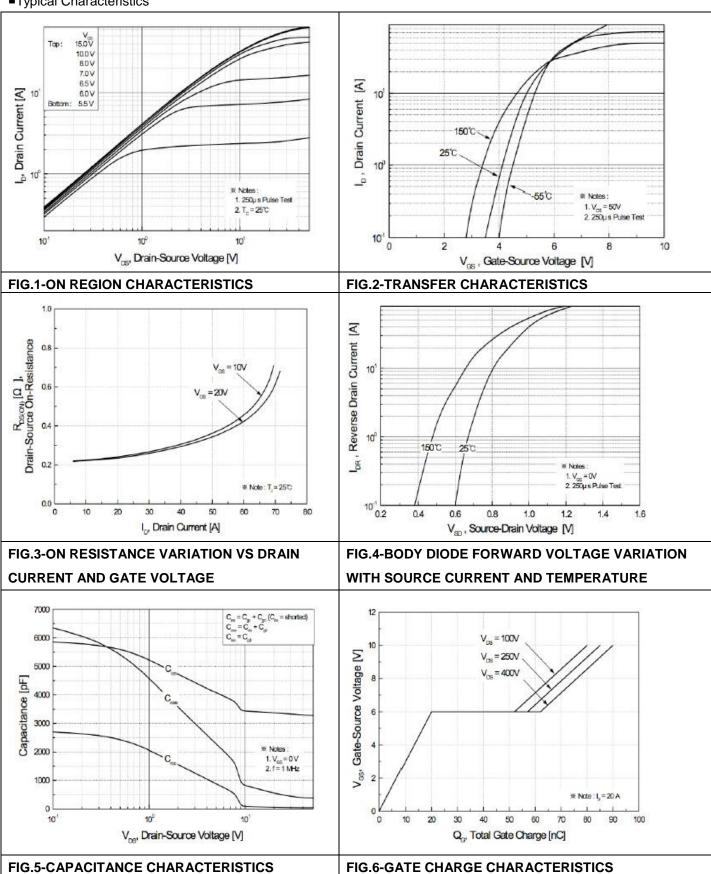
Notes;

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. I_{AS} =20A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} =25 $^{\circ}$ C
- 3. $I_{SD} \le 20A$, di/dt $\le 300A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C
- 4. Pulse Test: Pulse Width ≦ 300µs, Duty Cycle≦ 2%
- 5. Essentially Independent of Operating Temperature



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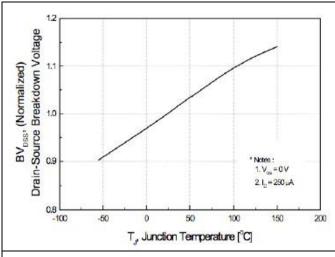
■Typical Characteristics





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■Typical Characteristics



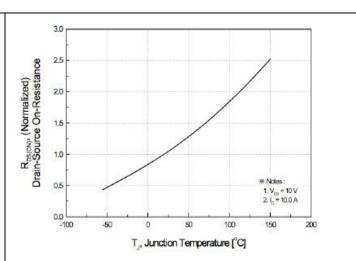


FIG.7-BREAKDOWN VOLTAGE VARIATION VS TEMPERATURE

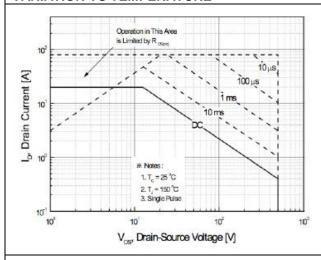


FIG.8-ON-RESISTANCE VARIATION VS TEMPERATURE

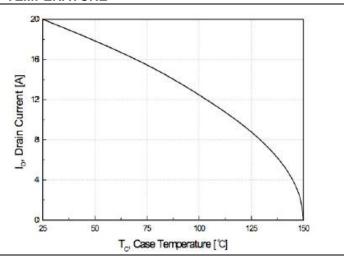


FIG.9-MAXIMUM SAFE OPERATING AREA

FIG.10-MAXIMUM DRAIN CURRENT VS CASE TEMPERATURE

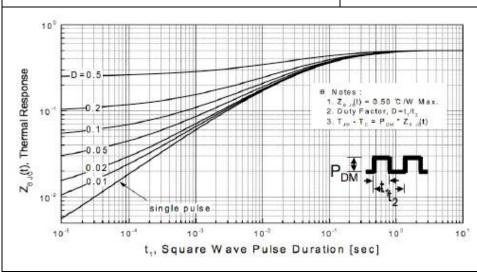


FIG.11-TRANSIENT THERMAL RESPONSE CURVE



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■Characteristics Test Circuit & Waveform

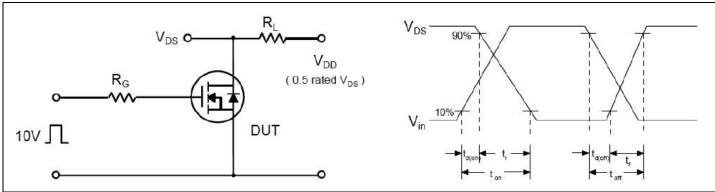


Fig 12. Resistive Switching Test Circuit & Waveforms

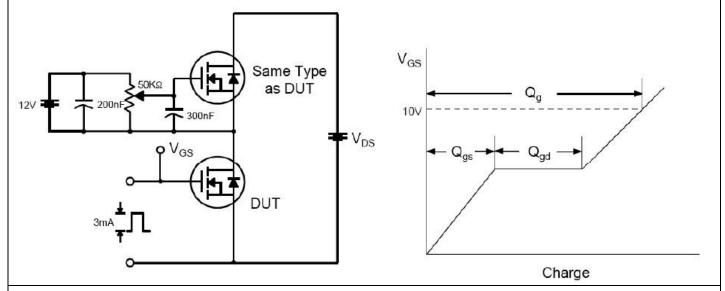
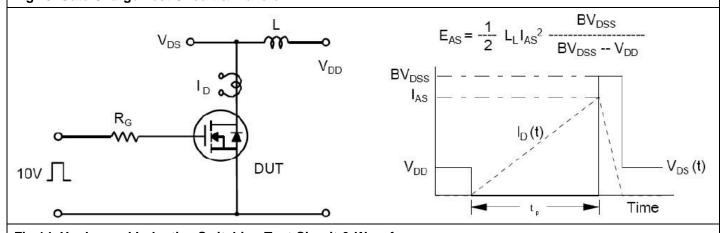


Fig 13. Gate Charge Test Circuit & Waveform





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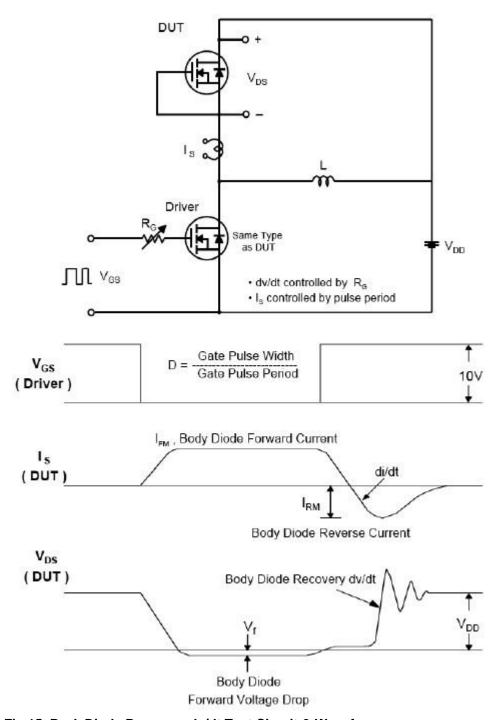


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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